

BT151 series

Thyristors

Rev. 03 — 7 June 2004

Product data sheet



1.1 General description

Passivated thyristors in a SOT78 plastic package.

1.2 Features

- High thermal cycling performance
- High bidirectional blocking voltage capability.

1.3 Applications

Motor control

Industrial and domestic lighting, heating and static switching.

1.4 Quick reference data

- V_{DRM} , $V_{RRM} \le 800 \text{ V (BT151-800R)}$
- V_{DRM} , $V_{RRM} \le 650 \text{ V (BT151-650R)}$
- V_{DRM}, V_{RRM} ≤ 500 V (BT151-500R)
- $I_{T(RMS)} \le 12 A$
- $I_{T(AV)} \le 7.5 \text{ A}$
- $I_{TSM} \le 120 \text{ A}$.

2. Pinning information

Table 1: Discrete pinning

idbic i.	Diodroto pinning		
Pin	Description	Simplified outline	Symbol
1	cathode (k)		N 1
2	anode (a)	mb	+
3	gate (g)		sym037
	mounting base; connected to anode (a)		
		1 2 3	
		SOT78 (TO-220AB)	





3. Ordering information

Table 2: Ordering information

Type number	Package	Package						
	Name	Description	Version					
BT151-500R	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole;	SOT78					
BT151-650R		3-lead TO-220AB						
BT151-800R								

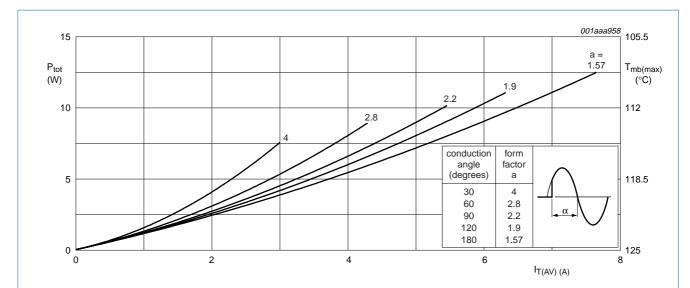
4. Limiting values

Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

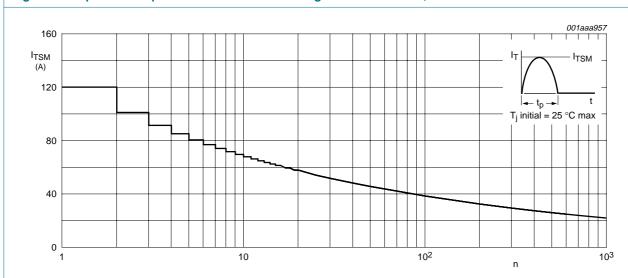
Symbol	Parameter	Conditions		Min	Max	Unit
V_{DRM}, V_{RRM}	repetitive peak off-state voltage					
	BT151-500R		<u>[1]</u>	-	500	V
	BT151-650R		<u>[1]</u>	-	650	V
	BT151-800R			-	800	V
I _{T(AV)}	average on-state current	half sinewave; T _{mb} ≤ 109 °C; <u>Figure 1</u>		-	7.5	Α
I _{T(RMS)}	RMS on-state current	all conduction angles; Figure 4 and Figure 5		-	12	Α
I _{TSM}	non-repetitive peak on-state current	half sinewave; $T_j = 25$ °C prior to surge; Figure 2 and Figure 3				
		t = 10 ms		-	120	Α
		t = 8.3 ms		-	132	Α
I ² t	I ² t for fusing	t = 10 ms		-	72	A ² s
dl _T /dt	repetitive rate of rise of on-state current after triggering	I_{TM} = 20 A; I_G = 50 mA; dI_G/dt 50 mA/ μ s		-	50	A/μs
I _{GM}	peak gate current			-	2	Α
V_{RGM}	peak reverse gate voltage			-	5	V
P _{GM}	peak gate power			-	5	W
P _{G(AV)}	average gate power	over any 20 ms period		-	0.5	W
T _{stg}	storage temperature			-40	+150	°C
T _j	junction temperature			-	125	°C

^[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/µs.



 $a = form factor = I_{T(RMS)}/I_{T(AV)}$.

Fig 1. Total power dissipation as a function of average on-state current; maximum values.



f = 50 Hz.

Fig 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values.

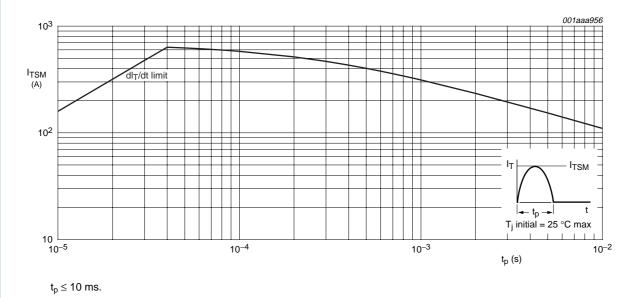


Fig 3. Non-repetitive peak on-state current as a function of pulse width; maximum values.

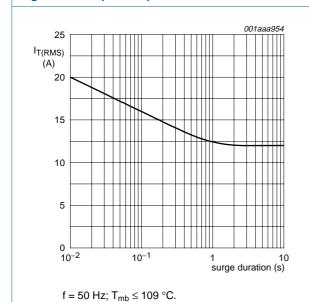


Fig 4. RMS on-state current as a function of surge duration; maximum values.

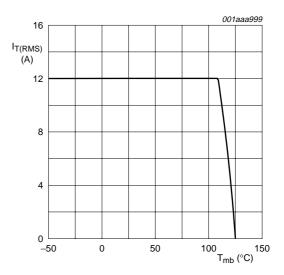


Fig 5. RMS on-state current as a function of mounting base temperature; maximum values.





Table 4: **Thermal characteristics**

Symbol	Parameter	Conditions	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Figure 6	-	1.3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	60	-	K/W

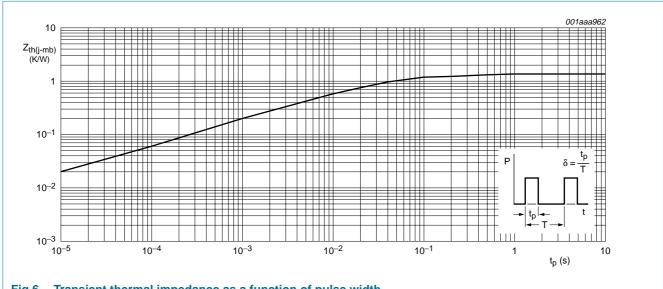


Fig 6. Transient thermal impedance as a function of pulse width.



6. Characteristics

Table 5: Characteristics

 $T_i = 25 \,^{\circ}C$ unless otherwise stated

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; <u>Figure 8</u>	-	2	15	mA
IL	latching current	V _D = 12 V; I _{GT} = 0.1 A; <u>Figure 10</u>	-	10	40	mA
I _H	holding current	V _D = 12 V; I _{GT} = 0.1 A; <u>Figure 11</u>	-	7	20	mA
V _T	on-state voltage	I _T = 23 A; <u>Figure 9</u>	-	1.4	1.75	V
V_{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; <u>Figure 7</u>	-	0.6	1.5	V
		$V_D = V_{DRM(max)}; I_T = 0.1 A;$ $T_j = 125 ^{\circ}C$	0.25	0.4	-	V
I _D , I _R	off-state leakage current	$V_D = V_{DRM(max)}$; $V_R = V_{RRM(max)}$; $T_j = 125 ^{\circ}C$	-	0.1	0.5	mA
Dynamic o	characteristics					
dV _D /dt	critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; Figure 12				
		gate open circuit	50	130	-	V/µs
		$R_{GK} = 100 \Omega$	200	1000	-	V/µs
t _{gt}	gate controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A/}\mu\text{s}$	-	2	-	μs
t _q	circuit commuted turn-on time	$V_D = 67\% \ V_{DRM(max)}; \ T_j = 125 \ ^{\circ}C; \ I_{TM} = 20 \ A; \ V_R = 25 \ V; \ dI_{TM}/dt = 30 \ A/\mu s; \ dV_D/dt = 50 \ V/\mu s; \ R_{GK} = 100 \ \Omega$	-	70	-	μs

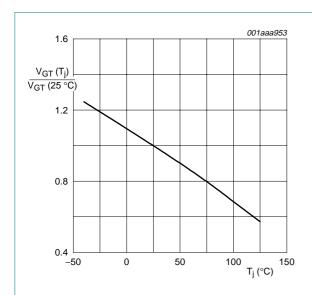


Fig 7. Normalized gate trigger voltage as a function of junction temperature.

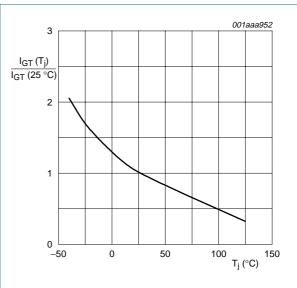
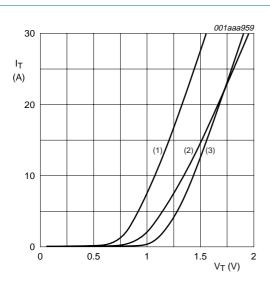


Fig 8. Normalized gate trigger current as a function of junction temperature.

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 $V_0 = 1.06 \text{ V}.$

 $R_S = 0.0304 \Omega$.

- (1) $T_i = 125$ °C; typical values.
- (2) $T_i = 125 \,^{\circ}C$; maximum values.
- (3) $T_j = 25$ °C; maximum values.

Fig 9. On-state current characteristics.

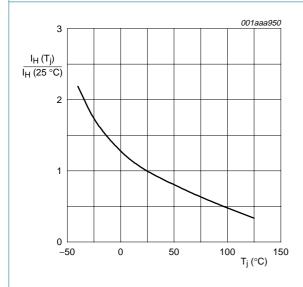


Fig 11. Normalized holding current as a function of junction temperature.

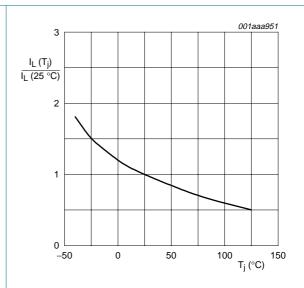
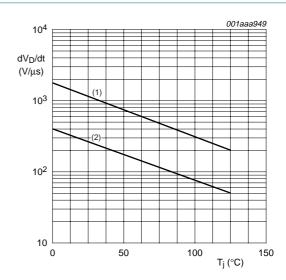


Fig 10. Normalized latching current as a function of junction temperature.



- (1) $R_{GK} = 100 \Omega$.
- (2) Gate open circuit.

Fig 12. Critical rate of rise of off-state voltage as a function of junction temperature; minimum values.

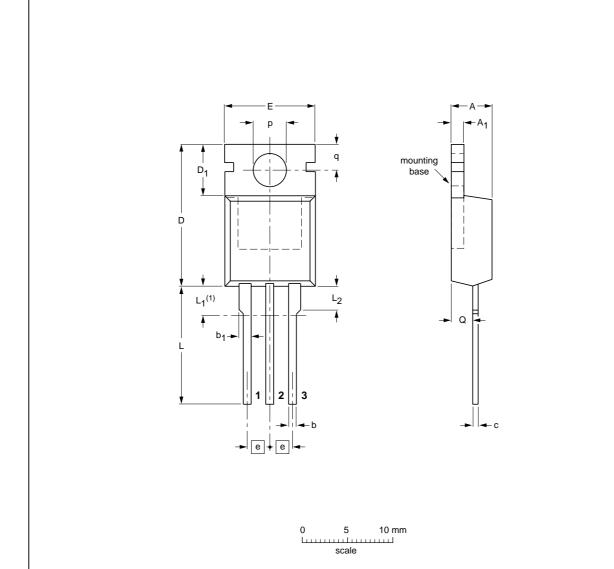
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7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78



DIMENSIONS (mm are the original dimensions)

UNIT	Α	A ₁	b	b ₁	С	D	D ₁	E	е	L	L ₁ ⁽¹⁾	L ₂	р	q	Q
mm	4.5 4.1	1.39	0.9	1.3	0.7 0.4	15.8 15.2	6.4 5.9	10.3 9.7	2.54	15.0 13.5	3.30 2.79	max. 3.0	3.8	3.0	2.6

Note

1. Terminals in this zone are not tinned.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT78		3-lead TO-220AB	SC-46			01-02-16 03-01-22	

Fig 13. Package outline





8. Revision history

Table 6: Revision history

Document ID	Release date	Data sheet status	Change notice	Order number	Supersedes	
BT151_SERIES_3	20040607	Product specification	-	9397 750 13159	BT151_SERIES_2	
Modifications:	Converted from Lotus Manuscript format to TDM format					

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Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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